

November 2013

## **FDMC86106LZ**

# N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET 100 V, 7.5 A, 103 m $\Omega$

### **Features**

- Shielded Gate MOSFET Technology
- Max  $r_{DS(on)}$  = 103 m $\Omega$  at  $V_{GS}$  = 10 V,  $I_D$  = 3.3 A
- Max  $r_{DS(on)}$  = 153 m $\Omega$  at  $V_{GS}$  = 4.5 V,  $I_D$  = 2.7 A
- HBM ESD protection level > 3 KV typical (Note 4)
- 100% UIL Tested
- RoHS Compliant

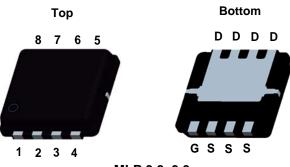


### **General Description**

This N-Channel logic Level MOSFETs are produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior switching performance. G-S zener has been added to enhance ESD voltage level.

### **Application**

■ DC - DC Conversion





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### **MOSFET Maximum Ratings** $T_A = 25$ °C unless otherwise noted

Symbol	Parameter	Parameter			
$V_{DS}$	Drain to Source Voltage			100	V
$V_{GS}$	Gate to Source Voltage			±20	V
	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25 °C		7.5	
	-Continuous (Silicon limited)	T <sub>C</sub> = 25 °C		9.6	^
ID	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	3.3	A
	-Pulsed			15	
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	12	mJ
Ъ	Power Dissipation $T_C = 25 ^{\circ}\text{C}$			19	W
$P_{D}$	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.3	VV
$T_J$ , $T_{STG}$	Operating and Storage Junction Temperature R	ange		-55 to +150	°C

### **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction to Case		6.5	°C/W
Rela	Thermal Resistance, Junction to Ambient	(Note 1a)	53	C/VV

### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC86106Z	FDMC86106LZ	Power 33	13 "	12 mm	3000 units

# **Electrical Characteristics** $T_J = 25$ °C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	100			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$ , referenced to 25 °C		73		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V			1	μΑ
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μΑ

### On Characteristics

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	1.0	1.8	2.2	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, referenced to 25 °C		-6		mV/°C
		$V_{GS} = 10 \text{ V}, I_D = 3.3 \text{ A}$		79	103	
r <sub>DS(on)</sub>	r <sub>DS(on)</sub> Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, I_D = 2.7 \text{ A}$		105	153	mΩ
, ,		$V_{GS} = 10 \text{ V}, I_D = 3.3 \text{ A}, T_J = 125 \text{ °C}$		136	178	
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 \text{ V}, I_{D} = 3.3 \text{ A}$		11		S

### **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	V 50 V V 0 V	232	310	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$	45	60	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 1 1011 12	2.4	5	pF
R <sub>g</sub>	Gate Resistance		0.7		Ω

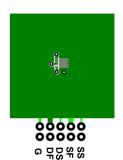
### **Switching Characteristics**

t <sub>d(on)</sub>	Turn-On Delay Time		4.5	10	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 3.3 A,	1.3	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$	10	20	ns
t <sub>f</sub>	Fall Time		1.4	10	ns
$Q_{g(TOT)}$	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V	4	6	nC
$Q_{g(TOT)}$	Total Gate Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 50 \text{ V},$ $I_{D} = 3.3 \text{ A}$	2	3	nC
$Q_{gs}$	Total Gate Charge	1 <sub>D</sub> = 3.3 A	0.8		nC
$Q_{gd}$	Gate to Drain "Miller" Charge		0.7		nC

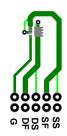
### **Drain-Source Diode Characteristics**

Vob Source to Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = 3.3 \text{ A}$ (Note 2)		0.85	1.3	\/	
	$V_{GS} = 0 \text{ V}, I_S = 2 \text{ A}$ (Note 2)		0.82	1.2	V	
t <sub>rr</sub>	Reverse Recovery Time	I <sub>E</sub> = 3.3 A. di/dt = 100 A/us		33	54	ns
Q <sub>rr</sub>	Reverse Recovery Charge			23	38	nC

<sup>1.</sup>  $R_{\theta JA}$  is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta CA}$  is determined by the user's board design.



a. 53 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper



b. 125 °C/W when mounted on a minimum pad of 2 oz copper

<sup>2.</sup> Pulse Test: Pulse Width < 300  $\mu\text{s},$  Duty cycle < 2.0%.

<sup>3.</sup> Starting T  $_{J}$  = 25 °C; N-ch: L = 1.0 mH, I  $_{AS}$  = 5.0 A, V  $_{DD}$  = 90 V, V  $_{GS}$  = 10 V.

<sup>4.</sup> The diode connected between gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

### Typical Characteristics T<sub>J</sub> = 25 °C unless otherwise noted

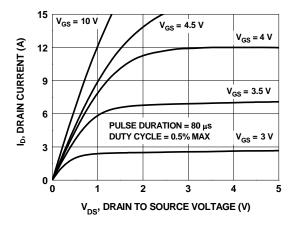


Figure 1. On Region Characteristics

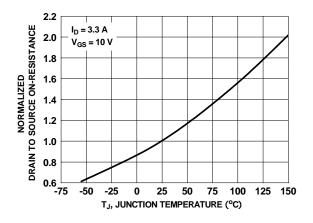


Figure 3. Normalized On Resistance vs Junction Temperature

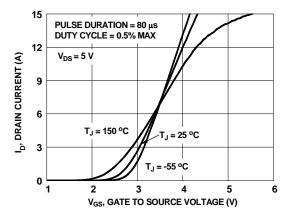


Figure 5. Transfer Characteristics

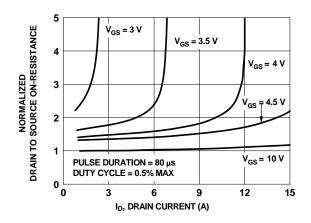


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

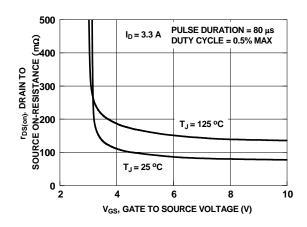


Figure 4. On-Resistance vs Gate to Source Voltage

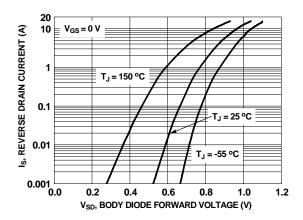


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

### **Typical Characteristics** $T_J = 25$ °C unless otherwise noted

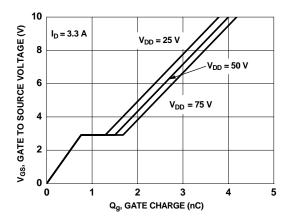


Figure 7. Gate Charge Characteristics

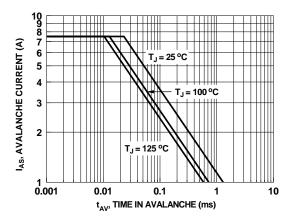


Figure 9. Unclamped Inductive Switching Capability

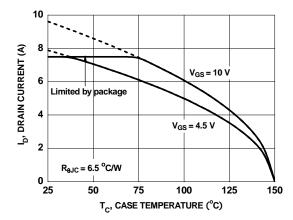


Figure 11. Maximum Continuous Drain Current vs Case Temperature

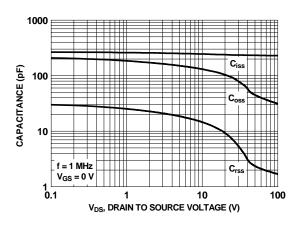


Figure 8. Capacitance vs Drain to Source Voltage

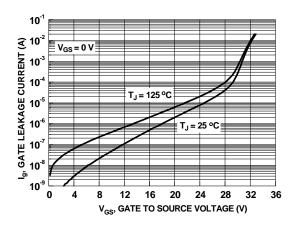


Figure 10. Gate Leakage Current vs Gate to Source Voltage

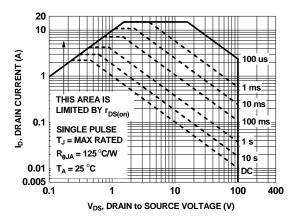


Figure 12. Forward Bias Safe Operating Area

### **Typical Characteristics** $T_J = 25$ °C unless otherwise noted

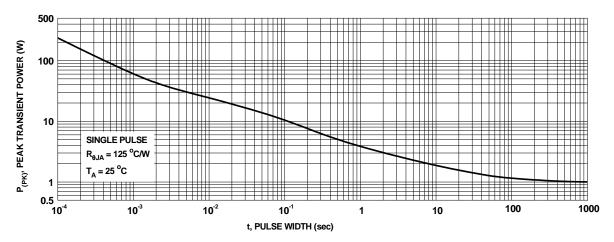


Figure 13. Single Pulse Maximum Power Dissipation

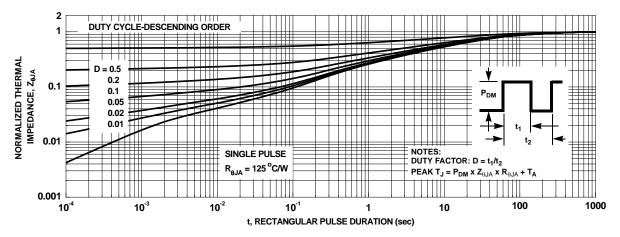
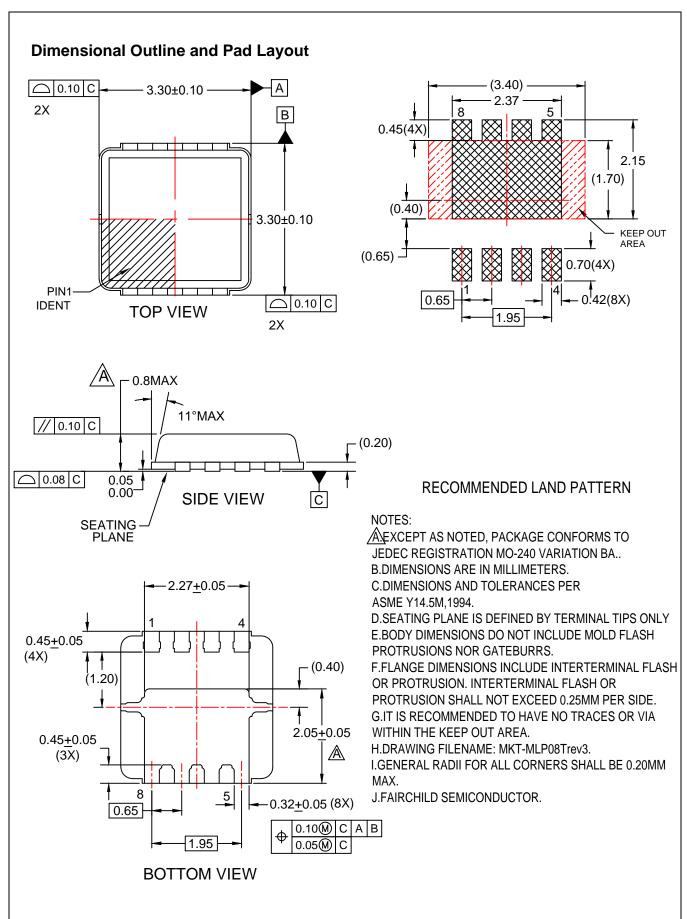


Figure 14. Junction-to-Ambient Transient Thermal Response Curve



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